

1 Products affected

| Product hierarchy no. * | | | | Part no. | SBU | Type / Description | Customer part no. |
|-------------------------|-----|-----|------------|---|--------------------|--------------------|-------------------|
| SBU | PG | PGU | Type | | | | |
| 01 | 002 | 030 | 0000000522 | 0031.8263 0031.8264 0031.8265 0031.8273 0031.8274 0031.8275 0031.8263.W 0031.8265.W 0031.8273.W 0031.8275.W 0031.9001 | Circuit Protection | OGN-SMD | |

*SBU (2-digit) / PG (3-digit) / PGU (3-digit) / Type (10-digit)

2 Type of change

Product improvement, change of material.

3 Detailed description of change

Change to a new thermoplastic material with a slightly different color shade

4 Reason of change

Changes on the OGN-SMD fuseholders to meet the enhanced reflow-soldering requirements.

5 Release date

The change came into effect on January 1st 2014 (date code 1401 or higher on label).

6 Impact of change and recommended action

Form: No influence (change of material and different color shade only)
Fit: No influence
Function: No influence
Production Site: No influence
Product Label: No influence

7 Reference Documents / Attachments

| Kind of document | Document number | Remarks |
|------------------|-----------------|----------------------------------|
| Datasheet | OGN-SMD | Web Link OGN-SMD |

| OGN-SMD | | | | | 0118.2207 | |
|---------------|------------|--------------|-------------|------------------|-----------|--------|
| creation date | created by | release date | released by | notification no. | revision | page |
| 2014-01-30 | arnetja | 2014-02-06 | dislercy | 25752 | b | 1 of 1 |